



## Terminal Voltages $\pm 5V$ , 100 Taps

# X9C102/103/104/503

## Digitally Controlled Potentiometer (XD<sub>DCP</sub><sup>TM</sup>)

### FEATURES

- Solid-state potentiometer
- 3-wire serial interface
- 100 wiper tap points
  - Wiper position stored in nonvolatile memory and recalled on power-up
- 99 resistive elements
  - Temperature compensated
  - End to end resistance,  $\pm 20\%$
  - Terminal voltages,  $\pm 5V$
- Low power CMOS
  - $V_{CC} = 5V$
  - Active current, 3mA max.
  - Standby current, 750 $\mu$ A max.
- High reliability
  - Endurance, 100,000 data changes per bit
  - Register data retention, 100 years
- X9C102 = 1 k $\Omega$
- X9C103 = 10 k $\Omega$
- X9C503 = 50 k $\Omega$
- X9C104 = 100 k $\Omega$
- Packages
  - 8-lead SOIC and DIP

### DESCRIPTION

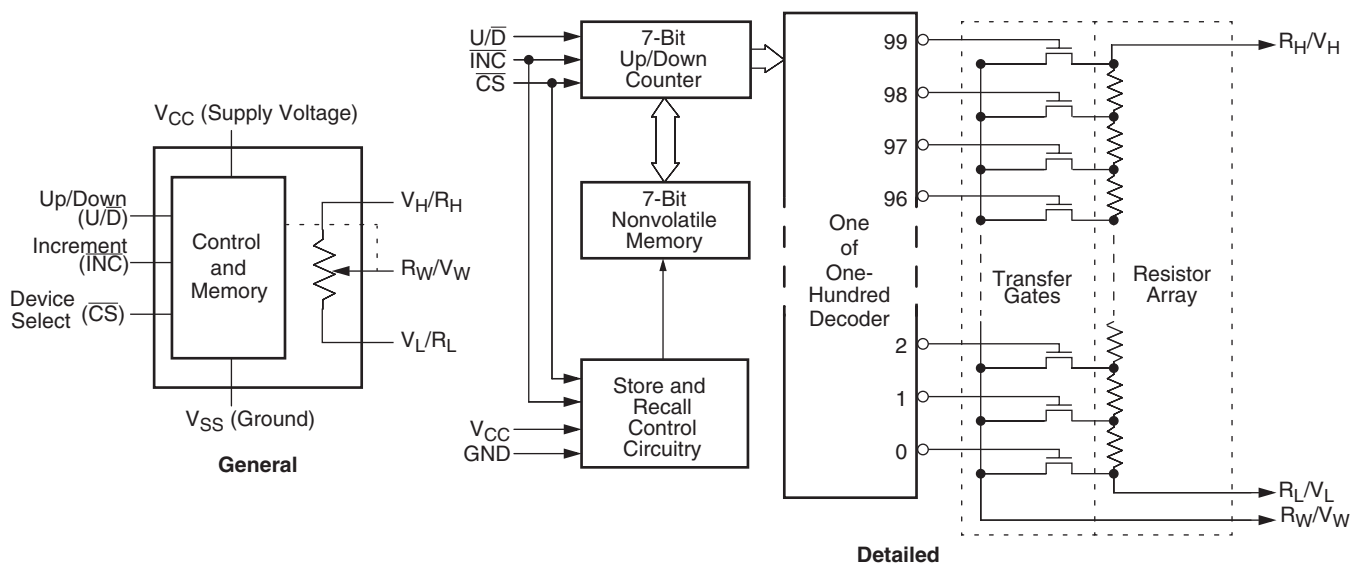
The X9Cxxx are Xicor digitally controlled (XD<sub>DCP</sub>) potentiometers. The device consists of a resistor array, wiper switches, a control section, and nonvolatile memory. The wiper position is controlled by a three-wire interface.

The potentiometer is implemented by a resistor array composed of 99 resistive elements and a wiper switching network. Between each element and at either end are tap points accessible to the wiper terminal. The position of the wiper element is controlled by the  $\overline{CS}$ , U/D, and INC inputs. The position of the wiper can be stored in nonvolatile memory and then be recalled upon a subsequent power-up operation.

The device can be used as a three-terminal potentiometer or as a two-terminal variable resistor in a wide variety of applications including:

- control
- parameter adjustments
- signal processing

### BLOCK DIAGRAM



# X9C102/103/104/503

## PIN DESCRIPTIONS

### $R_H/V_H$ and $R_L/V_L$

The high ( $V_H/R_H$ ) and low ( $V_L/R_L$ ) terminals of the X9C102/103/104/503 are equivalent to the fixed terminals of a mechanical potentiometer. The minimum voltage is  $-5V$  and the maximum is  $+5V$ . The terminology of  $V_H/R_H$  and  $V_L/R_L$  references the relative position of the terminal in relation to wiper movement direction selected by the  $U/\bar{D}$  input and not the voltage potential on the terminal.

### $R_W/V_W$

$V_W/R_W$  is the wiper terminal, and is equivalent to the movable terminal of a mechanical potentiometer. The position of the wiper within the array is determined by the control inputs. The wiper terminal series resistance is typically  $40\Omega$ .

### Up/Down ( $U/\bar{D}$ )

The  $U/\bar{D}$  input controls the direction of the wiper movement and whether the counter is incremented or decremented.

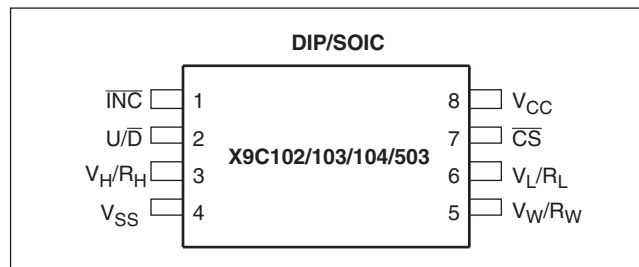
### Increment ( $\bar{INC}$ )

The  $\bar{INC}$  input is negative-edge triggered. Toggling  $\bar{INC}$  will move the wiper and either increment or decrement the counter in the direction indicated by the logic level on the  $U/\bar{D}$  input.

### Chip Select ( $\bar{CS}$ )

The device is selected when the  $\bar{CS}$  input is LOW. The current counter value is stored in nonvolatile memory when  $\bar{CS}$  is returned HIGH while the  $\bar{INC}$  input is also HIGH. After the store operation is complete the X9C102/103/104/503 device will be placed in the low power standby mode until the device is selected once again.

## PIN CONFIGURATION



## PIN NAMES

Symbol	Description
$V_H/R_H$	High Terminal
$V_W/R_W$	Wiper Terminal
$V_L/R_L$	Low Terminal
$V_{SS}$	Ground
$V_{CC}$	Supply Voltage
$U/\bar{D}$	Up/Down Control Input
$\bar{INC}$	Increment Control Input
$\bar{CS}$	Chip Select Control Input
NC	No Connection

## PRINCIPLES OF OPERATION

There are three sections of the X9Cxxx: the input control, counter and decode section; the nonvolatile memory; and the resistor array. The input control section operates just like an up/down counter. The output of this counter is decoded to turn on a single electronic switch connecting a point on the resistor array to the wiper output. Under the proper conditions the contents of the counter can be stored in nonvolatile memory and retained for future use. The resistor array is comprised of 99 individual resistors connected in series. At either end of the array and between each resistor is an electronic switch that transfers the potential at that point to the wiper.

The wiper, when at either fixed terminal, acts like its mechanical equivalent and does not move beyond the last position. That is, the counter does not wrap around when clocked to either extreme.

The electronic switches on the device operate in a "make before break" mode when the wiper changes tap positions. If the wiper is moved several positions, multiple taps are connected to the wiper for  $t_{1W}$  ( $\bar{INC}$  to  $V_W/R_W$  change). The  $R_{TOTAL}$  value for the device can temporarily be reduced by a significant amount if the wiper is moved several positions.

When the device is powered-down, the last wiper position stored will be maintained in the nonvolatile memory. When power is restored, the contents of the memory are recalled and the wiper is set to the value last stored.

## INSTRUCTIONS AND PROGRAMMING

The  $\overline{INC}$ ,  $U/\overline{D}$  and  $\overline{CS}$  inputs control the movement of the wiper along the resistor array. With  $\overline{CS}$  set LOW the device is selected and enabled to respond to the  $U/\overline{D}$  and  $\overline{INC}$  inputs. HIGH to LOW transitions on  $\overline{INC}$  will increment or decrement (depending on the state of the  $U/\overline{D}$  input) a seven-bit counter. The output of this counter is decoded to select one of one-hundred wiper positions along the resistive array.

The value of the counter is stored in nonvolatile memory whenever  $\overline{CS}$  transitions HIGH while the  $\overline{INC}$  input is also HIGH.

The system may select the X9Cxxx, move the wiper, and deselect the device without having to store the latest wiper position in nonvolatile memory. After the wiper movement is performed as described above and once the new position is reached, the system must keep  $\overline{INC}$  LOW while taking  $\overline{CS}$  HIGH. The new wiper position will be maintained until changed by the system or until a power-down/up cycle recalled the previously stored data.

This procedure allows the system to always power-up to a preset value stored in nonvolatile memory; then during system operation minor adjustments could be made. The adjustments might be based on user preference: system parameter changes due to temperature drift, etc...

The state of  $U/\overline{D}$  may be changed while  $\overline{CS}$  remains LOW. This allows the host system to enable the device and then move the wiper up and down until the proper trim is attained.

## MODE SELECTION

$\overline{CS}$	$\overline{INC}$	$U/\overline{D}$	Mode
L		H	Wiper Up
L		L	Wiper Down
	H	X	Store Wiper Position
H	X	X	Standby Current
	L	X	No Store, Return to Standby

## SYMBOL TABLE

WAVEFORM	INPUTS	OUTPUTS
	Must be steady	Will be steady
	May change from Low to High	Will change from Low to High
	May change from High to Low	Will change from High to Low
	Don't Care: Changes Allowed	Changing: State Not Known
	N/A	Center Line is High Impedance

# X9C102/103/104/503

## ABSOLUTE MAXIMUM RATINGS

Temperature under bias .....-65°C to +135°C  
 Storage temperature .....-65°C to +150°C  
 Voltage on  $\overline{CS}$ ,  $\overline{INC}$ ,  $U/\overline{D}$  and  $V_{CC}$   
 with respect to  $V_{SS}$ .....-1V to +7V  
 Voltage on  $V_H/R_H$  and  $V_L/R_L$   
 referenced to  $V_{SS}$  .....-8V to +8V  
 $\Delta V = |V_H/R_H - V_L/R_L|$   
 X9C102 ..... 4V  
 X9C103, X9C503, and X9C104 ..... 10V  
 Lead temperature (soldering, 10 seconds)..... +300°C  
 $I_W$  (10 seconds) ..... 8.8mA

## COMMENT

Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only; functional operation of the device (at these or any other conditions above those listed in the operational sections of this specification) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## RECOMMENDED OPERATING CONDITIONS

Temperature	Min.	Max.
Commercial	0°C	+70°C
Industrial	-40°C	+85°C
Military	-55°C	+125°C

Supply Voltage ( $V_{CC}$ )	Limits
X9C102/103/104/503	5V $\pm$ 10%

## POTENTIOMETER CHARACTERISTICS (Over recommended operating conditions unless otherwise stated.)

Symbol	Parameter	Limits			Unit	Test Conditions/Notes
		Min.	Typ.	Max.		
$R_{TOTAL}$	End to end resistance variation	-20		+20	%	
$V_{VH/RH}$	$V_H$ terminal voltage	-5		+5	V	
$V_{VL/RL}$	$V_L$ terminal voltage	-5		+5	V	
	Power rating			16	mW	X9C102
	Power rating			10	mW	X9C103/104/503
$I_W$	Wiper current	-4.4		4.4	mA	
$R_W$	Wiper resistance		40	100	$\Omega$	Wiper Current = $\pm$ 1mA
	Noise		-120		dBV	Ref. 1kHz
	Resolution		1		%	
	Absolute linearity <sup>(1)</sup>	-1		+1	M <sup>(3)</sup>	$V_{W(n)(actual)} - V_{W(n)(expected)}$
	Relative linearity <sup>(2)</sup>	-0.2		+0.2	MI <sup>(3)</sup>	$V_{W(n+1)(actual)} - [V_{W(n)} + MI]$
	RTOTAL temperature coefficient		$\pm$ 300		ppm/°C	X9C103/503/104
	RTOTAL temperature coefficient		$\pm$ 600		ppm/°C	X9C102
$C_H/C_L/C_W$	Potentiometer capacitances		10/10/25		pF	See Circuit #3, Macro Model

- Notes:** (1) Absolute linearity is utilized to determine actual wiper voltage versus expected voltage =  $[V_{W(n)(actual)} - V_{W(n)(expected)}] = \pm 1$  MI Maximum.  
 (2) Relative linearity is a measure of the error in step size between taps =  $V_{W(n+1)} - [V_{W(n)} + MI] = +0.2$  MI.  
 (3) 1 MI = Minimum Increment =  $R_{TOT}/99$   
 (4) Typical values are for  $T_A = 25^\circ\text{C}$  and nominal supply voltage.  
 (5) This parameter is not 100% tested.

# X9C102/103/104/503

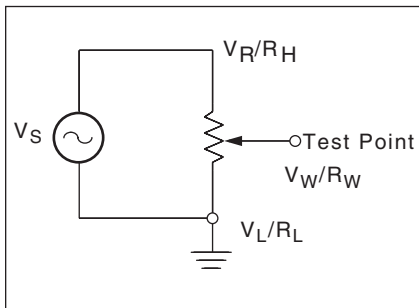
## D.C. OPERATING CHARACTERISTICS (Over recommended operating conditions unless otherwise specified.)

Symbol	Parameter	Limits			Unit	Test Conditions
		Min.	Typ. <sup>(4)</sup>	Max.		
$I_{CC}$	$V_{CC}$ active current		1	3	mA	$\overline{CS} = V_{IL}$ , $U/\overline{D} = V_{IL}$ or $V_{IH}$ and $\overline{INC} = 0.4V$ to $2.4V$ @ max. $t_{CYC}$
$I_{SB}$	Standby supply current		200	750	$\mu A$	$\overline{CS} = V_{CC} - 0.3V$ , $U/\overline{D}$ and $\overline{INC} = V_{SS}$ or $V_{CC} - 0.3V$
$I_{LI}$	$\overline{CS}$ , $\overline{INC}$ , $U/\overline{D}$ input leakage current			$\pm 10$	$\mu A$	$V_{IN} = V_{SS}$ to $V_{CC}$
$V_{IH}$	$\overline{CS}$ , $\overline{INC}$ , $U/\overline{D}$ input HIGH voltage	2		$V_{CC} + 1$	V	
$V_{IL}$	$\overline{CS}$ , $\overline{INC}$ , $U/\overline{D}$ input LOW voltage	-1		0.8	V	
$C_{IN}^{(2)}$	$\overline{CS}$ , $\overline{INC}$ , $U/\overline{D}$ input capacitance			10	pF	$V_{CC} = 5V$ , $V_{IN} = V_{SS}$ , $T_A = 25^\circ C$ , $f = 1MHz$

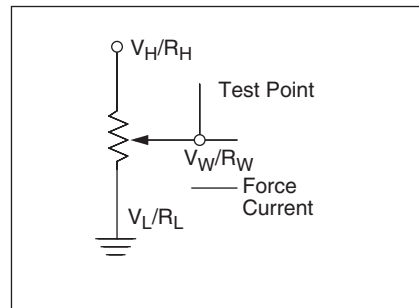
## ENDURANCE AND DATA RETENTION

Parameter	Min.	Unit
Minimum endurance	100,000	Data changes per bit per register
Data retention	100	years

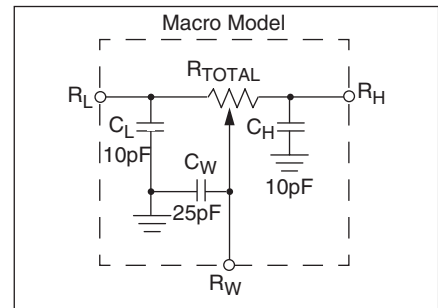
Test Circuit #1



Test Circuit #2



Test Circuit #3



# X9C102/103/104/503

## A.C. CONDITIONS OF TEST

Input pulse levels	0V to 3V
Input rise and fall times	10ns
Input reference levels	1.5V

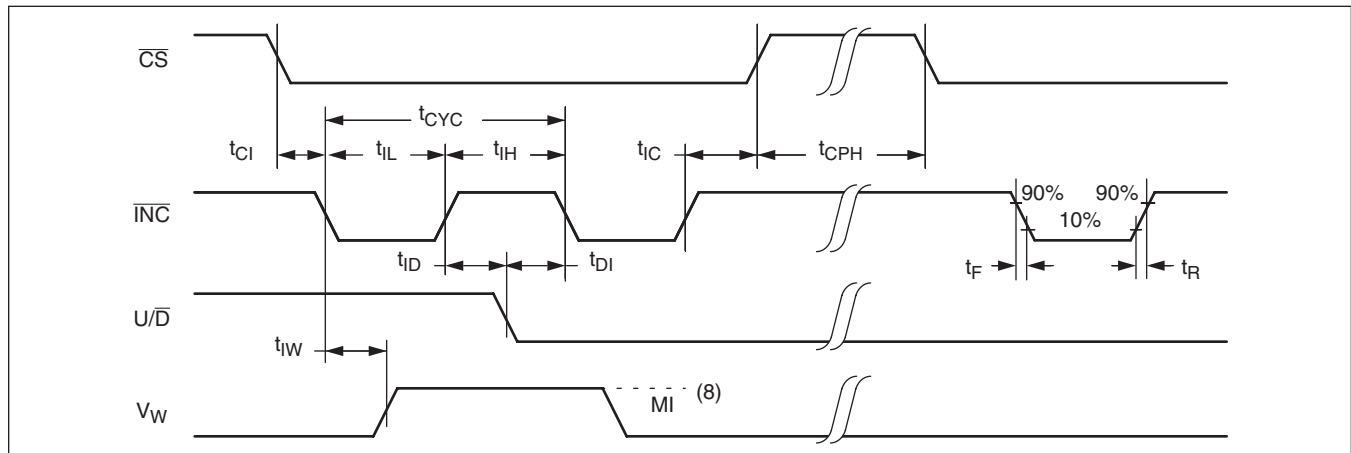
## A.C. OPERATING CHARACTERISTICS (Over recommended operating conditions unless otherwise specified)

Symbol	Parameter	Limits			Unit
		Min.	Typ. <sup>(6)</sup>	Max.	
$t_{CI}$	$\overline{CS}$ to $\overline{INC}$ setup	100			ns
$t_{ID}$	$\overline{INC}$ HIGH to U/D change	100			ns
$t_{DI}$	U/D to $\overline{INC}$ setup	2.9			$\mu$ s
$t_{IL}$	$\overline{INC}$ LOW period	1			$\mu$ s
$t_{IH}$	$\overline{INC}$ HIGH period	1			$\mu$ s
$t_{IC}$	$\overline{INC}$ inactive to $\overline{CS}$ inactive	1			$\mu$ s
$t_{CPH}$	$\overline{CS}$ deselect time (STORE)	20			ms
$t_{CPH}$	$\overline{CS}$ deselect time (NO STORE)	100			ns
$t_{IW}$	$\overline{INC}$ to $V_W/RW$ change		100	500	$\mu$ s
$t_{CYC}$	$\overline{INC}$ cycle time	4			$\mu$ s
$t_R, t_F^{(7)}$	$\overline{INC}$ input rise and fall time			500	$\mu$ s
$t_{PU}^{(7)}$	Power up to wiper stable			500	$\mu$ s
$t_R V_{CC}^{(7)}$	$V_{CC}$ power-up rate	0.2		50	V/ms

## POWER UP AND DOWN REQUIREMENTS

There are no restrictions on the sequencing of bias supplies  $V_{CC}$ ,  $V_+$ , and  $V_-$  provided that all three supplies reach their final values within 1msec of each other. At all times, voltages on the potentiometer pins must be less than  $V_+$  and more than  $V_-$ . The recall of the wiper position from nonvolatile memory is not in effect until all supplies reach their final value. The  $V_{CC}$  ramp rate spec is always in effect.

## A.C. TIMING



**Notes:** (6) Typical values are for  $T_A = 25^\circ\text{C}$  and nominal supply voltage.

(7) This parameter is periodically sampled and not 100% tested.

(8) MI in the A.C. timing diagram refers to the minimum incremental change in the  $V_W$  output due to a change in the wiper position.

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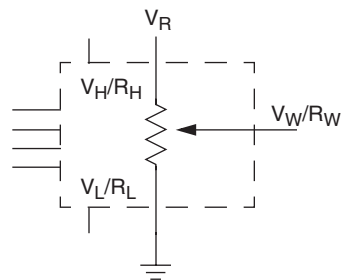
## PERFORMANCE CHARACTERISTICS

Contact the factory for more information.

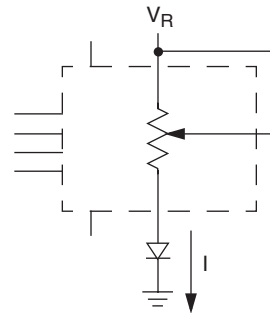
## APPLICATIONS INFORMATION

Electronic digitally controlled (XCDP) potentiometers provide three powerful application advantages; (1) the variability and reliability of a solid-state potentiometer, (2) the flexibility of computer-based digital controls, and (3) the retentivity of nonvolatile memory used for the storage of multiple potentiometer settings or data.

### Basic Configurations of Electronic Potentiometers



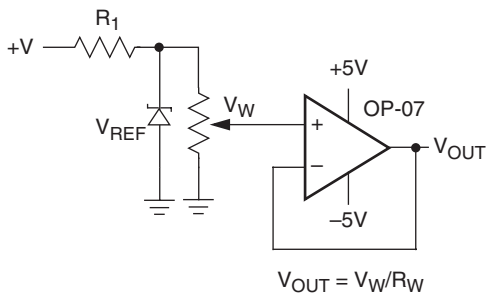
Three terminal potentiometer; variable voltage divider



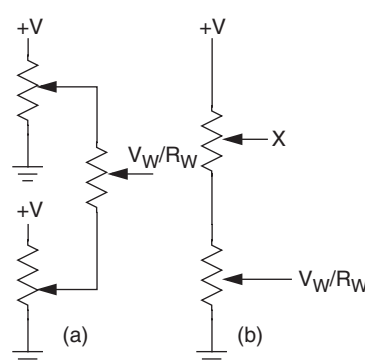
Two terminal variable resistor; variable current

### Basic Circuits

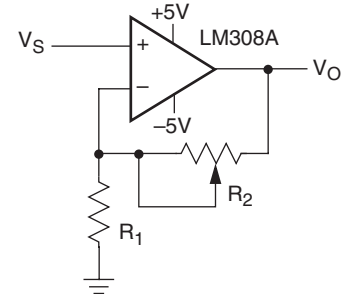
#### Buffered Reference Voltage



#### Cascading Techniques

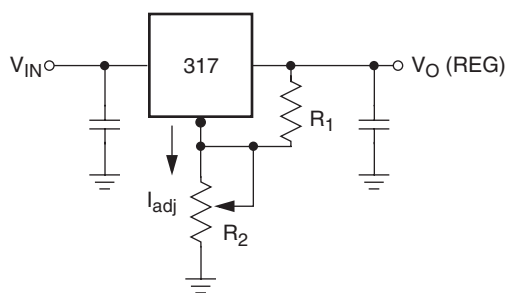


#### Noninverting Amplifier



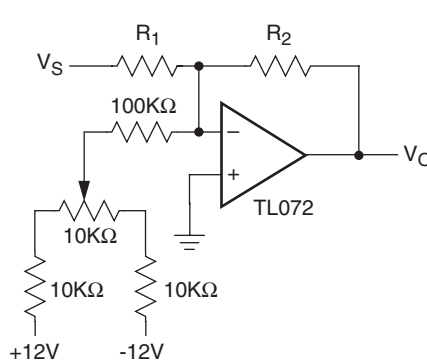
$$V_O = (1 + R_2/R_1)V_S$$

#### Voltage Regulator

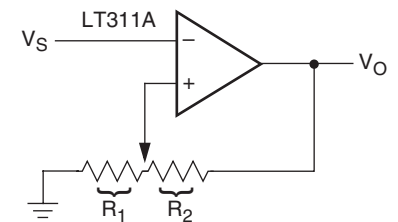


$$V_O (\text{REG}) = 1.25V (1 + R_2/R_1) + I_{\text{adj}} R_2$$

#### Offset Voltage Adjustment



#### Comparator with Hysteresis



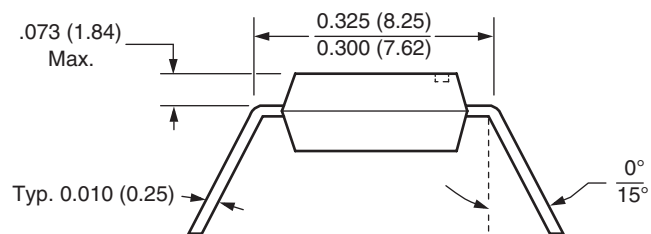
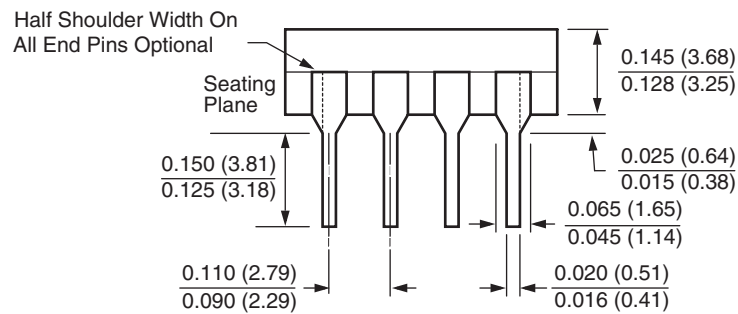
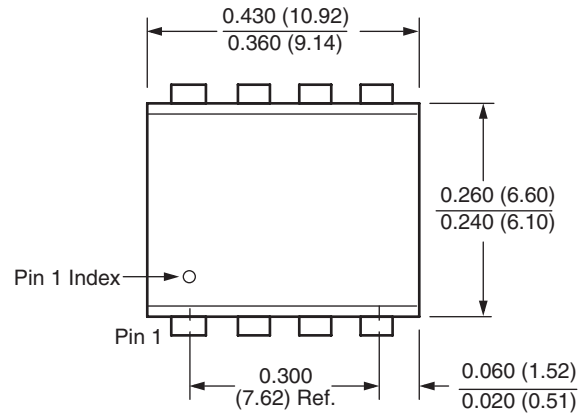
$$V_{UL} = \{R_1/(R_1 + R_2)\} V_O(\text{max})$$

$$V_{LL} = \{R_1/(R_1 + R_2)\} V_O(\text{min})$$

(for additional circuits see AN115)

## PACKAGING INFORMATION

### 8-Lead Plastic Dual In-Line Package Type P



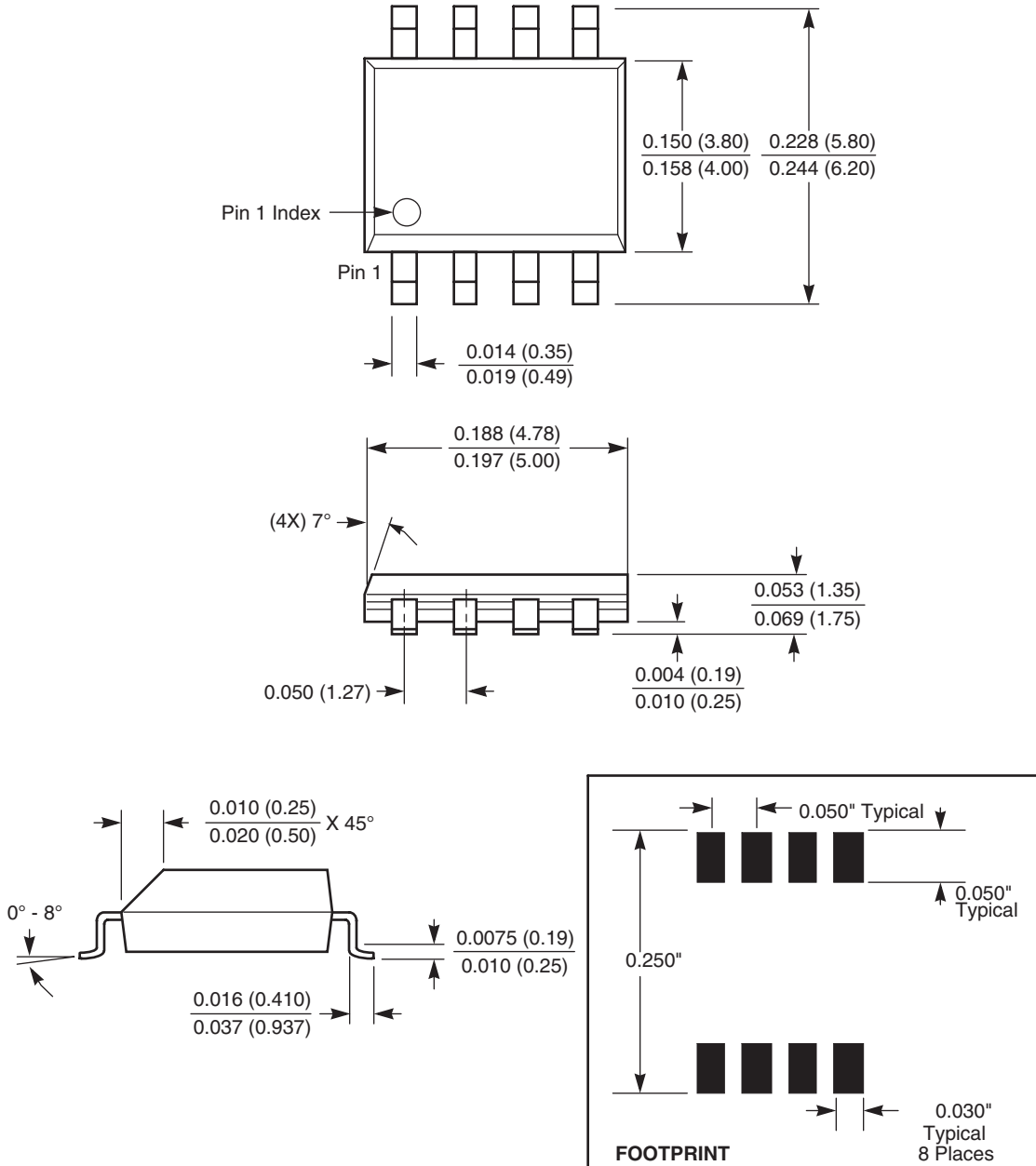
**NOTE:**

1. ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)
2. PACKAGE DIMENSIONS EXCLUDE MOLDING FLASH



PACKAGING INFORMATION

8-Lead Plastic Small Outline Gull Wing Package Type S

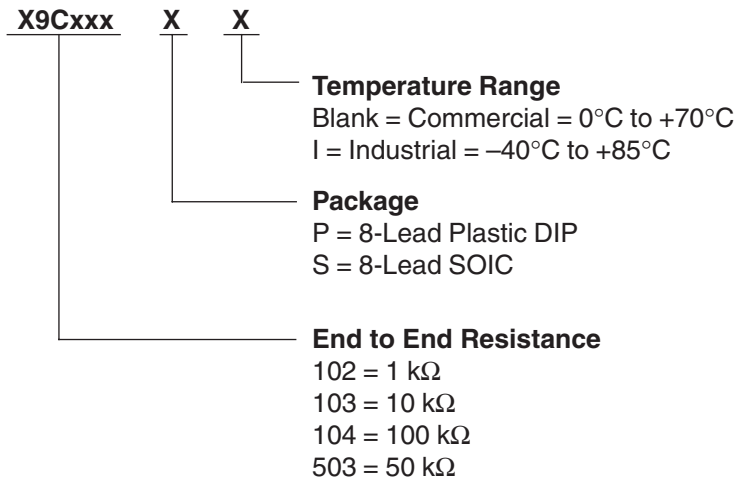


NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

# X9C102/103/104/503

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## Ordering Information



## Physical Characteristics

Marking Includes:

- Manufacturer's Trademark
- Resistance Value or Code
- Date Code

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### LIMITED WARRANTY

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### LIFE RELATED POLICY

In situations where semiconductor component failure may endanger life, system designers using this product should design the system with appropriate error detection and correction, redundancy and back-up features to prevent such an occurrence.

Xicor's products are not authorized for use in critical components in life support devices or systems.

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.